

### **Features**

- ESD Protection for 1 Line with Bi-directional
- Provide ESD protection for each line to IEC 61000-4-2 (ESD) ±30kV (air / contact) IEC 61000-4-4 (EFT) 80A (5/50ns)
   IEC 61000-4-5 (Lightning) 2.5A (8/20µs)
- Suitable for, 21V and below, operating voltage applications
- 0201 small CSP package saves board space
- Protect one I/O line or one power line
- Fast turn-on and low clamping voltage
- Solid-state silicon-avalanche and active circuit triggering technology
- Green part

## **Applications**

- Mobile Phones
- Hand Held Portable Applications
- Computer Interfaces Protection
- Microprocessors Protection
- Serial and Parallel Port Protection
- Control Signal Lines Protection
- Power Lines on PCB Protection
- Latchup Protection

## **Description**

AZ4A21-01B is a design which includes a bi-directional ESD rated clamping cell to protect one power line, or one control line, or one low speed data line in an electronic system. The AZ4A21-01B has been specifically designed to protect sensitive components which are connected to power and control lines from over-voltage damage and latch-up caused by

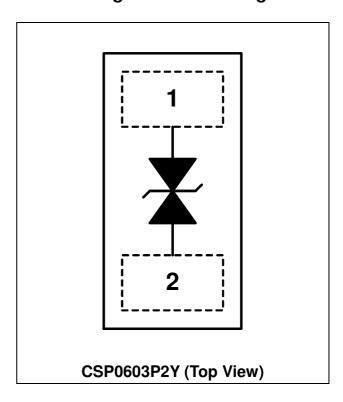
Electrostatic Discharging (ESD), Electrical Fast Transients (EFT), and Cable Discharge Event (CDE).

AZ4A21-01B is a unique design which includes proprietary clamping cell in a single package. During transient conditions, the proprietary clamping cell prevents over-voltage on the power line or control/data lines, protecting any downstream components.

AZ4A21-01B is bi-directional and may be used on lines where the signal swings above and below ground.

AZ4A21-01B may be used to meet the ESD immunity requirements of IEC 61000-4-2, Level 4 (±15kV air, ±8kV contact discharge).

## **Circuit Diagram / Pin Configuration**



## **SPECIFICATIONS**

ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25°C, unless otherwise specified)			
PARAMETER	SYMBOL	RATING	UNITS
Peak Pulse Current (tp=8/20μs)	I <sub>PP</sub>	2.5	Α
Operating Supply Voltage	$V_{DC}$	±23.1	V
ESD per IEC 61000-4-2 (Air)	V <sub>ESD-1</sub>	±30	kV
ESD per IEC 61000-4-2 (Contact)	$V_{ESD-2}$	±30	
Lead Soldering Temperature	T <sub>SOL</sub>	260 (10 sec.)	°C
Operating Temperature	T <sub>OP</sub>	-55 to +125	°C
Storage Temperature	T <sub>STO</sub>	-55 to +150	°C

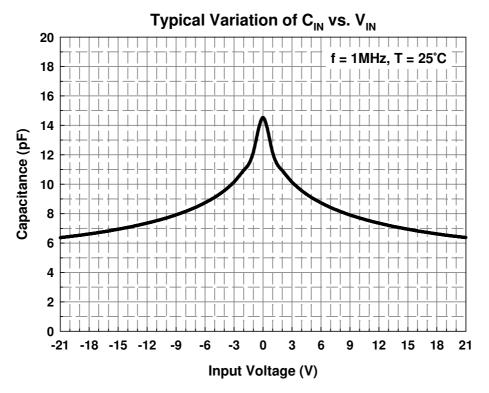
ELECTRICAL CHARACTERISTICS						
PARAMETER	SYMBOL	OL CONDITIONS		TYP	MAX	UNITS
Reverse Stand-Off Voltage	$V_{RWM}$	T=25 °C.	-21		21	٧
Reverse Leakage Current	I <sub>Leak</sub>	V <sub>RWM</sub> =±21V, T=25 °C.			100	nA
Reverse Breakdown Voltage	$V_{BV}$	I <sub>BV</sub> =1mA, T=25 °C.	23.8		27.8	٧
ESD Clamping Voltage (Note 1)	$V_{clamp}$	IEC 61000-4-2 +8kV (I <sub>TLP</sub> = 16A), Contact mode, T=25 °C.		30		<b>V</b>
ESD Dynamic Turn-on Resistance	$R_{ ext{dynamic}}$	IEC 61000-4-2, 0~+8kV, Contact mode, T=25 °C.		0.27		Ω
Channel Input Capacitance	C <sub>IN</sub>	V <sub>R</sub> = 0V, f = 1MHz, T=25 °C.		15	20	pF

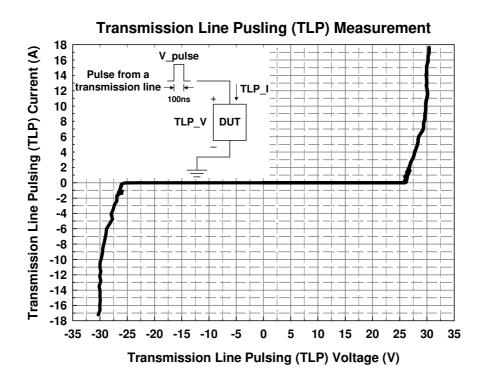
Note 1: ESD Clamping Voltage was measured by Transmission Line Pulsing (TLP) System.

TLP conditions:  $Z_0 = 50\Omega$ ,  $t_p = 100$ ns,  $t_r = 1$ ns.



## **Typical Characteristics**







### **Applications Information**

The AZ4A21-01B is designed to protect one line against system ESD/EFT pulses by clamping it to an acceptable reference. It provides bi-directional protection.

The usage of the AZ4A21-01B is shown in Fig. 1. Protected line, such as data line, control line, or power line, is connected at pin 1. The pin 2 is connected to a ground plane on the board. In order to minimize parasitic inductance in the board traces, all path lengths connected to the pins of AZ4A21-01B should be kept as short as possible.

In order to obtain enough suppression of ESD induced transient, good circuit board is critical. Thus, the following guidelines are recommended:

- Minimize the path length between the protected lines and the AZ4A21-01B.
- Place the AZ4A21-01B near the input terminals or connectors to restrict transient coupling.
- The ESD current return path to ground should be kept as short as possible.
- Use ground planes whenever possible.
- NEVER route critical signals near board edges and near the lines which the ESD transient easily injects to.

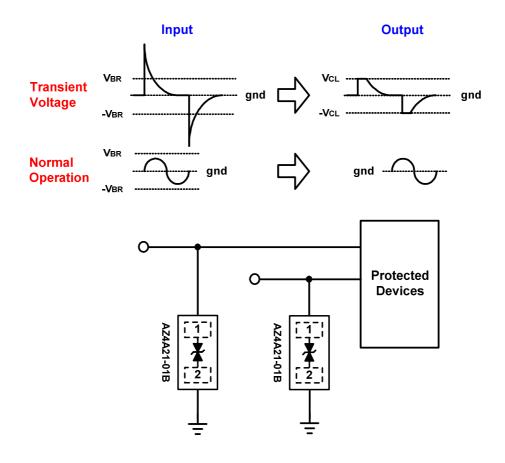
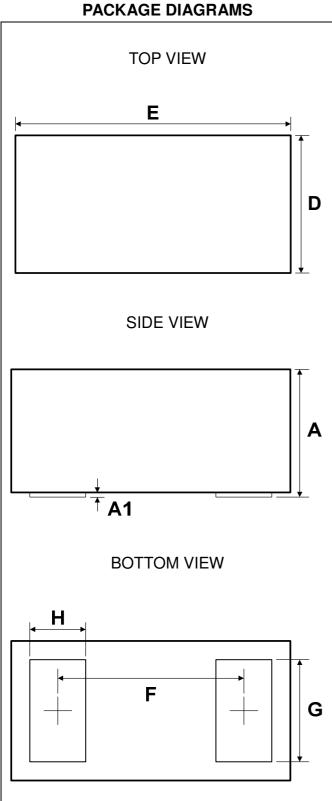


Fig. 1



# Mechanical Details CSP0603P2Y PACKAGE DIAGRAM

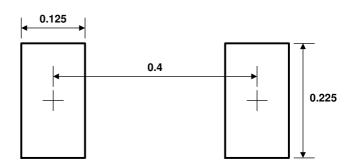


### **PACKAGE DIMENSIONS**

Symbol	Millimeters			
	MIN.	TYP.	MAX.	
D	0.275	0.300	0.325	
E	0.575	0.600	0.625	
Α	0.256	0.276	0.296	
<b>A</b> 1		0.011		
F		0.400		
G	0.210	0.220	0.230	
Н	0.110	0.120	0.130	

### LAND LAYOUT

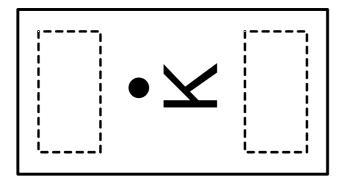
### Unit: mm



### Notes:

This LAND LAYOUT is for reference purposes only. Please consult your manufacturing partners to ensure your company's PCB design guidelines are met.

### **MARKING CODE**



Part Number	Marking Code		
AZ4A21-01B.R7G (Green Part)	К		

Note. Green means Pb-free, RoHS, and Halogen free compliant.

K = Device Code

**Ordering Information** 

PN#	Material	Type	Reel size	MOQ	MOQ/internal box	MOQ/carton
AZ4A21-01B.R7G	Green	T/R	7 inch	15,000/reel	4  reels = 60,000/box	6 boxes = 360,000/carton

# **Revision History**

Revision	Modification Description
Revision 2017/05/17	Formal Release.